



**THE DATASHEET OF
DESD1LIN2WSQ-7**



Product Summary

| V _{BR} (Min) | I _{PP} (Max) | C _T (Typ) |
|-----------------------|-----------------------|----------------------|
| 25.4V & 17.1V | 3A | 13pF |

Features and Benefits

- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±30kV, Contact ±30kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **The DESD1LIN2WSQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.**

<https://www.diodes.com/quality/product-definitions/>

Description and Applications

This DIODES™ DESD1LIN2WSQ is a next generation ESD and surge protection device packaged in a small footprint surface mount package. It is qualified to AEC-Q101, supported by a PPAP and is designed to protect one data line of the Local Information Network (LIN) in an automotive.

- LIN bus protections

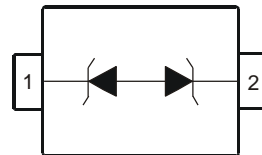
Mechanical Data

- Package: SOD323
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead-Free Plating). Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.005 grams (Approximate)

SOD323



Top View



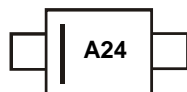
Device Schematic

Ordering Information (Note 4)

| Part Number | Package | Marking | Reel Size (inches) | Tape Width (mm) | Packing | |
|----------------|---------|---------|--------------------|-----------------|---------|-------------|
| | | | | | Qty. | Carrier |
| DESD1LIN2WSQ-7 | SOD323 | A24 | 7 | 8 | 3,000 | Tape & Reel |

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



A24 = Product Type Marking Code
Bar Denotes Pin 1

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | Conditions |
|------------------------------------|--------------------------|-------|------|------------------------|
| Peak Pulse Power Dissipation | PPP | 160 | W | 8/20μs, Per Figure 1 |
| Peak Pulse Current | I _{PP} | 3.0 | A | 8/20μs, Per Figure 1 |
| ESD Protection – Contact Discharge | V _{ESD_Contact} | ±30 | kV | Standard IEC 61000-4-2 |
| ESD Protection – Air Discharge | V _{ESD_Air} | ±30 | kV | Standard IEC 61000-4-2 |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Package Power Dissipation (Note 5) | P _D | 250 | mW |
| Thermal Resistance, Junction to Ambient (Note 5) | R _{θJA} | 500 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +150 | °C |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Conditions |
|---|-------------------|------|------|------|------|--|
| Reverse Standoff Voltage, from Pin 1 to Pin 2 | V _{RWM1} | — | — | 15 | V | — |
| Reverse Standoff Voltage, from Pin 2 to Pin 1 | V _{RWM2} | — | — | 24 | V | — |
| Channel Leakage Current, from Pin 1 to Pin 2 (Note 6) | I _{RM1} | — | 1 | 50 | nA | V _{RWM} = 15V |
| Channel Leakage Current, from Pin 2 to Pin 1 (Note 6) | I _{RM2} | — | 1 | 50 | nA | V _{RWM} = 24V |
| Breakdown Voltage, from Pin 1 to Pin 2 | V _{BR1} | 17.1 | 18.9 | 20.3 | V | I _R = 1mA |
| Breakdown Voltage, from Pin 2 to Pin 1 | V _{BR2} | 25.4 | 27.8 | 30.3 | V | I _R = 1mA |
| Clamping Voltage, from Pin 1 to Pin 2 | V _{CL1} | — | — | 25 | V | I _{PP} = 1A, t _P = 8/20μs |
| | | — | — | 35 | V | I _{PP} = 5A, t _P = 8/20μs |
| Clamping Voltage, from Pin 2 to Pin 1 | V _{CL2} | — | — | 40 | V | I _{PP} = 1A, t _P = 8/20μs |
| | | — | — | 50 | V | I _{PP} = 3A, t _P = 8/20μs |
| Clamping Voltage TLP, from Pin 1 to Pin 2 | V _{CL} | — | 23.5 | — | V | I _{TLP} = 16A, t _P = 100ns |
| | | — | 26.6 | — | V | I _{TLP} = 30A, t _P = 100ns |
| Clamping Voltage TLP, from Pin 2 to Pin 1 | V _{CL} | — | 33 | — | V | I _{TLP} = 16A, t _P = 100ns |
| | | — | 37.7 | — | V | I _{TLP} = 30A, t _P = 100ns |
| Differential Resistance | R _{DIF} | — | 0.5 | — | Ω | I _R = 1A, t _P = 8/20μs |
| Channel Input Capacitance | C _T | — | 13 | 17 | pF | V _R = 0V, f = 1MHz |
| | | — | — | 100 | pF | V _R = 12V, f = 100kHz |

- Notes:
5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at <http://www.diodes.com/package-outlines.html>.
 6. Short duration pulse test used to minimize self-heating effect.

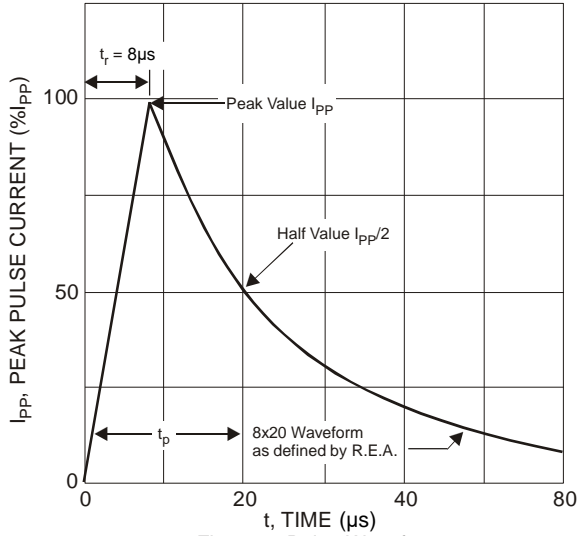


Figure 1 Pulse Waveform

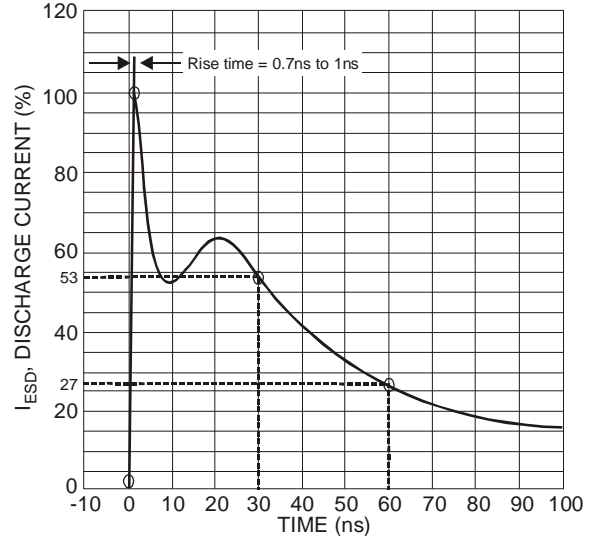


Figure 2 ESD Discharge Current Wave Form
IEC 61000-4-2 (330Ω/150pF)

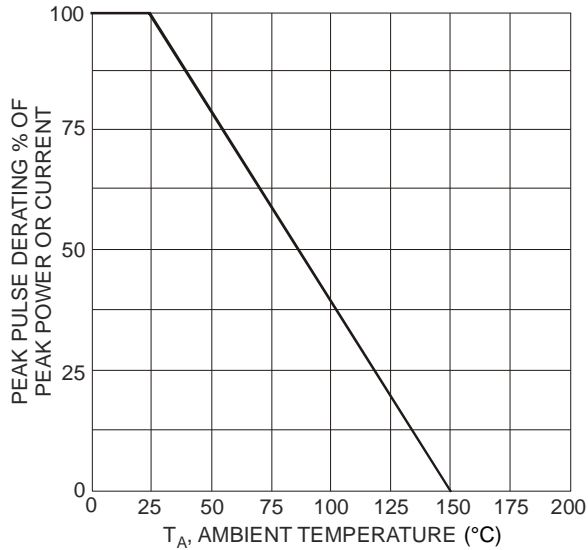


Figure 3 Power Dissipation vs. Ambient Temperature

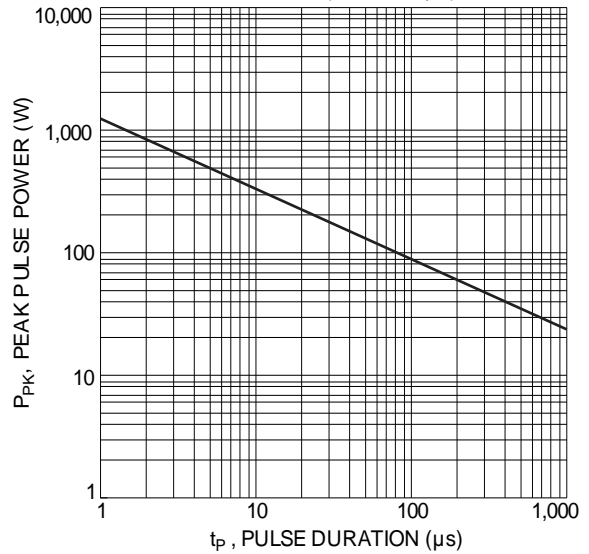


Figure 4 Peak Pulse Power vs. Pulse Duration

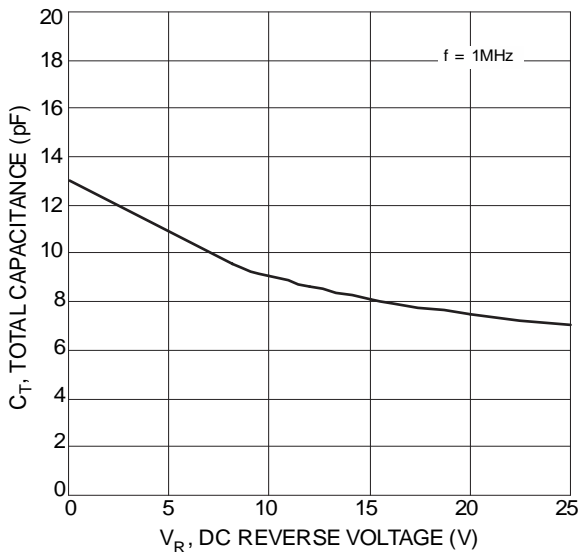


Figure 5 Total Capacitance vs. Reverse Voltage

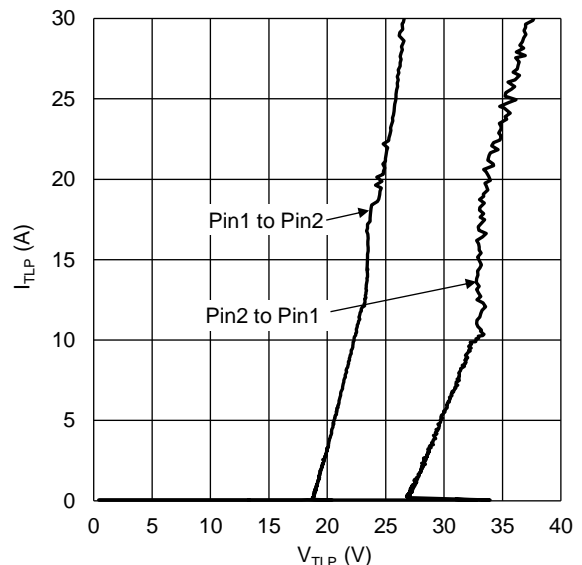


Figure 6 TLP I-V Curve

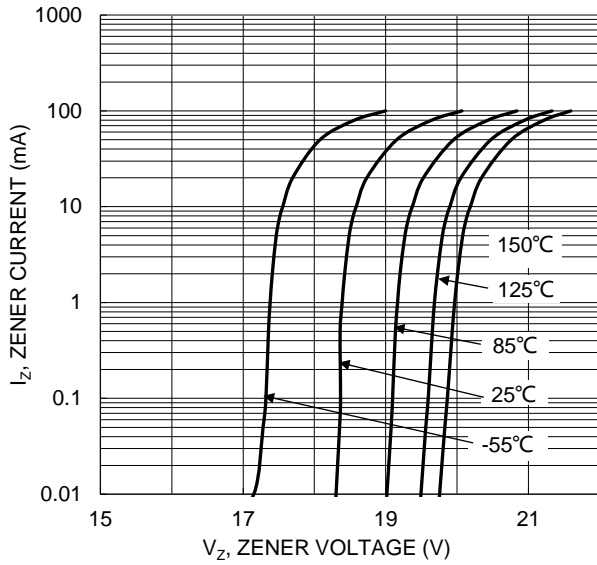


Figure 7 Typical Reverse Characteristics

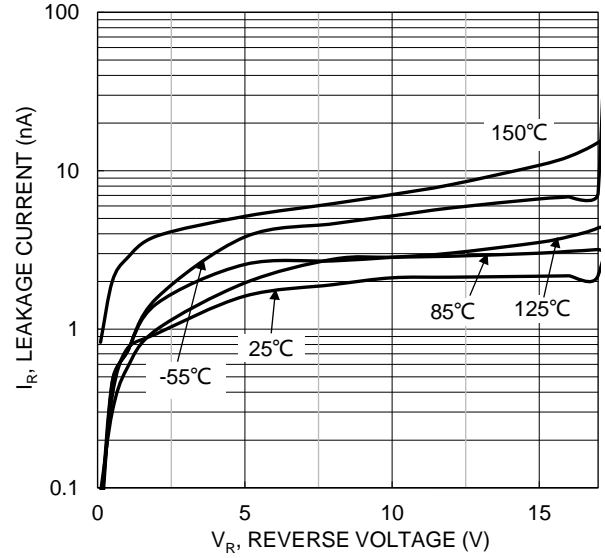
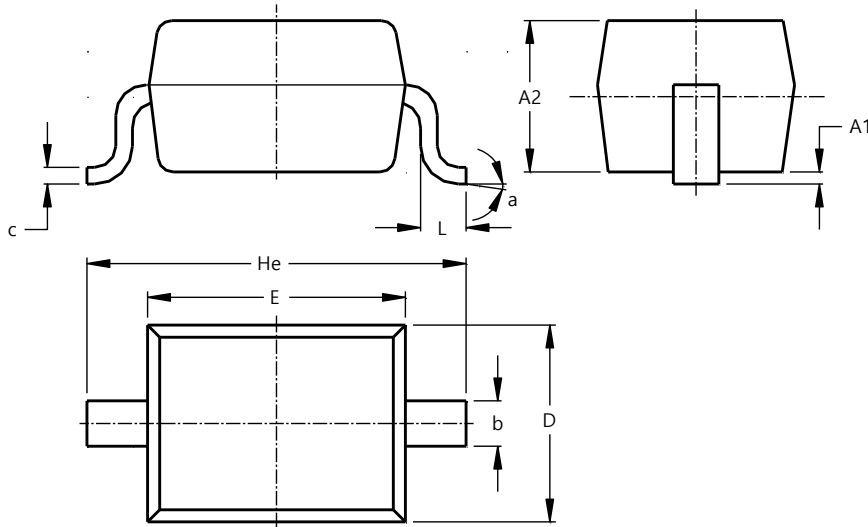


Figure 8 I_R vs. V_R Temperature Characteristic

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOD323

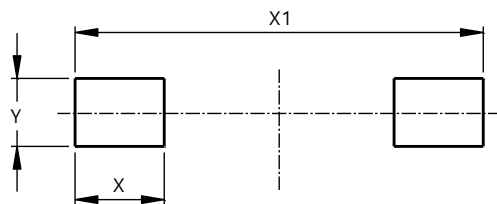


| SOD323 | | | |
|----------------------|------|------|------|
| Dim | Min | Max | Typ |
| A1 | -- | 0.10 | 0.05 |
| A2 | 1.00 | 1.10 | 1.05 |
| b | 0.25 | 0.35 | 0.30 |
| c | 0.10 | 0.15 | 0.11 |
| D | 1.20 | 1.40 | 1.30 |
| E | 1.60 | 1.80 | 1.70 |
| He | 2.30 | 2.70 | 2.50 |
| L | 0.20 | 0.40 | 0.30 |
| a | 0° | 8° | -- |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOD323



| Dimensions | Value (in mm) |
|------------|---------------|
| X | 0.590 |
| X1 | 2.700 |
| Y | 0.450 |

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